VN02NSP

HIGH SIDE SMART POWER SOLID STATE RELAY

TYPE	VDSS	R _{DS(on)}	Ιουτ	Vcc
VN02NSP	60 V	0.4 Ω	6 A	26 V

SGS-THOMSON MICROELECTRONICS

- OUTPUT CURRENT (CONTINUOUS): 6A @ T_c=25°C
- 5V LOGIC LEVEL COMPATIBLE INPUT
- THERMAL SHUT-DOWN
- UNDER VOLTAGE SHUT-DOWN
- OPEN DRAIN DIAGNOSTIC OUTPUT
- VERY LOW STAND-BY POWER DISSIPATION

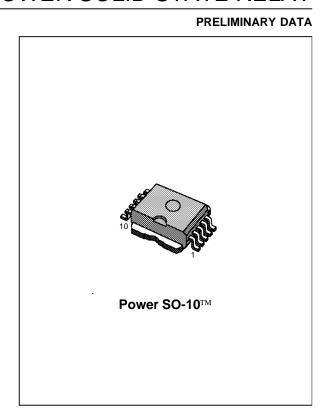
DESCRIPTION

The VN02NSP is a monolithic device made using SGS-THOMSON Vertical Intelligent Power Technology, intended for driving resistive or inductive loads with one side grounded.

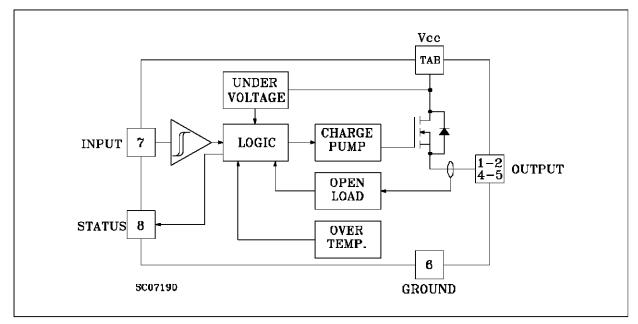
Built-in thermal shut-down protects the chip from over temperature and short circuit.

The input control is 5V logic level compatible.

The open drain diagnostic output indicates open circuit (no load) and over temperature status.



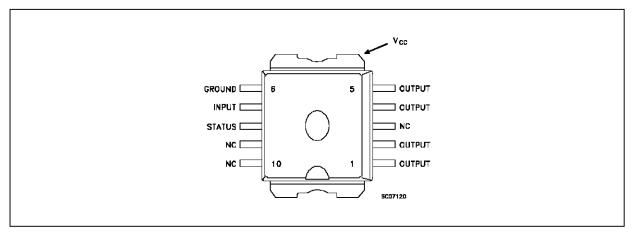
BLOCK DIAGRAM



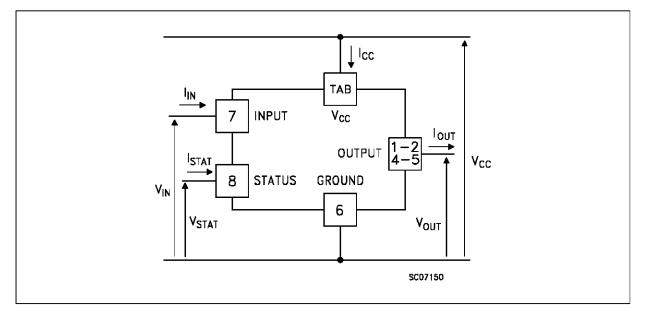
ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Value	Unit
V _{(BR)DSS}	Drain-Source Breakdown Voltage	60	V
Іоит	Output Current (cont.)	6	A
I _R	Reverse Output Current	-6	A
I _{IN}	Input Current	±10	mA
-Vcc	Reverse Supply Voltage	-4	V
I _{STAT}	Status Current	±10	mA
Vesd	Electrostatic Discharge (1.5 kΩ, 100 pF)	2000	V
Ptot	Power Dissipation at $T_c \le 25$ °C	29	W
Tj	Junction Operating Temperature	-40 to 150	°C
T _{stg}	Storage Temperature	-55 to 150	°C

CONNECTION DIAGRAM



CURRENT AND VOLTAGE CONVENTIONS





THERMAL DATA

R _{thj-case}	Thermal Resistance Junction-case	Мах	4.35	°C/W				
R _{thj-amb}	Thermal Resistance Junction-ambient (\$)	Мах	50	°C/W				
(f) \//ham maai	() When mounted using minimum recommended and size on FD 4 heard							

(\$) When mounted using minimum recommended pad size on FR-4 board

ELECTRICAL CHARACTERISTICS (V_{CC} = 13 V; -40 \leq T_j \leq 125 ^{o}C unless otherwise specified) POWER

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Vcc	Supply Voltage		7		26	V
Ron	On State Resistance	Iout = 3 A Iout = 3 A T _j = 25 °C			0.8 0.4	Ω Ω
Is	Supply Current	$\begin{array}{lll} \mbox{Off State} & T_j \geq 25 \ ^o\mbox{C} \\ \mbox{On State} & \end{array}$			50 15	μA mA

SWITCHING

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on Delay Time Of Output Current	$I_{OUT} = 3 \text{ A Resistive Load}$ Input Rise Time < 0.1 µs T _j = 25 °C		10		μs
tr	Rise Time Of Output Current	I_{OUT} = 3 A Resistive Load Input Rise Time < 0.1 µs T _j = 25 °C		15		μs
t _{d(off)}	Turn-off Delay Time Of Output Current	$I_{OUT} = 3 \text{ A Resistive Load}$ Input Rise Time < 0.1 µs T _j = 25 °C		15		μs
t _f	Fall Time Of Output Current	I_{OUT} = 3 A Resistive Load Input Rise Time < 0.1 µs T _j = 25 °C		6		μs
(di/dt) _{on}	Turn-on Current Slope	Iout = 3 A Iout = Iov			0.5 2	A/μs A/μs
(di/dt) _{off}	Turn-off Current Slope	I _{OUT} = 3 A I _{OUT} = I _{OV}			2 4	A/μs A/μs

LOGIC INPUT

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
VIL	Input Low Level Voltage				0.8	V
V _{IH}	Input High Level Voltage		2		(*)	V
V _{I(hyst.)}	Input Hysteresis Voltage			0.5		V
lin	Input Current	$V_{IN} = 5 V$		250	500	μΑ
VICL	Input Clamp Voltage	I _{IN} = 10 mA I _{IN} = -10 mA		6 -0.7		V V

PROTECTIONS AND DIAGNOSTICS

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{STAT} (•)	Status Voltage Output Low	I _{STAT} = 1.6 mA			0.4	V
V _{USD}	Under Voltage Shut Down			6.5		V



ELECTRICAL CHARACTERISTICS (continued)

PROTECTION AND DIAGNOSTICS (continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{SCL} (•)	Status Clamp Voltage	I _{STAT} = 10 mA I _{STAT} = -10 mA		6 -0.7		V V
tsc	Switch-off Time in Short Circuit Condition at Start-Up	$R_{LOAD} < 10 \text{ m}\Omega$ $T_c = 25 ^{\circ}\text{C}$		1.5	5	ms
lov	Over Current	$R_{\text{LOAD}} < 10 \text{ m}\Omega \qquad -40 \le T_c \le 125 ^{\circ}\text{C}$			28	A
I _{AV}	Average Current in Short Circuit	$R_{LOAD} < 10 \text{ m}\Omega$ $T_c = 85 ^{\circ}\text{C}$		0.9		A
Iol	Open Load Current Level		5		70	mA
T _{TSD}	Thermal Shut-down Temperature		140			°C
T _R	Reset Temperature		125			°C

(*) The V_{IH} is internally clamped at 6V about. It is possible to connect this pin to an higher voltage via an external resistor calculated to not exceed 10 mA at the input pin.

(•) Status determination > 100 μ s after the switching edge.

FUNCTIONAL DESCRIPTION

The device has a diagnostic output which indicates open circuit (no load) and over temperature conditions. The output signals are processed by internal logic.

To protect the device against short circuit and over-current condition, the thermal protection turns the integrated Power MOS off at a minimum junction temperature of 140 °C. When the temperature returns to about 125 °C the switch is automatically turned on again.

In short circuit conditions the protection reacts with virtually no delay, the sensor being located in the region of the die where the heat is generated.

PROTECTING THE DEVICE AGAINST REVER-SE BATTERY

The simplest way to protect the device against a continuous reverse battery voltage (-26V) is to insert a Schottky diode between pin 1 (GND) and ground, as shown in the typical application circuit (fig. 3).

The consequences of the voltage drop across this diode are as follows:

- If the input is pulled to power GND, a negative voltage of -V_F is seen by the device. (V_{IL}, V_{IH} thresholds and V_{STAT} are increased by V_F with respect to power GND).
- The undervoltage shutdown level is increased by V_F.

If there is no need for the control unit to handle external analog signals referred to the power GND, the best approach is to connect the reference potential of the control unit to node [1] (see application circuit in fig. 4), which becomes the common signal GND for the whole control board.

In this way no shift of V_{IH} , V_{IL} and V_{STAT} takes place and no negative voltage appears on the INPUT pin; this solution allows the use of a standard diode, with a breakdown voltage able to handle any ISO normalized negative pulses that occours in the automotive environment.



TRUTH TABLE

	INPUT	OUTPUT	DIAGNOSTIC
Normal Operation	L	L	Н
	Н	Н	Н
Open Circuit (No Load)	Н	Н	L
Over-temperature	Н	L	L
Under-voltage	Х	L	Н

Figure 1: Waveforms

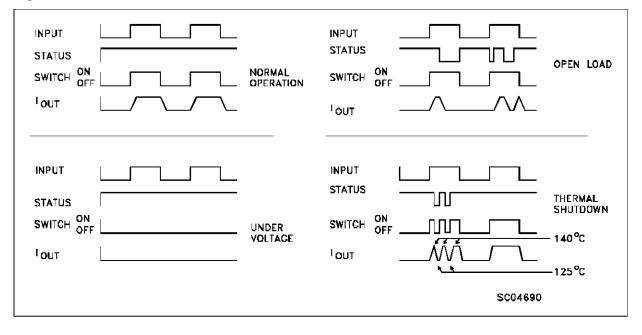
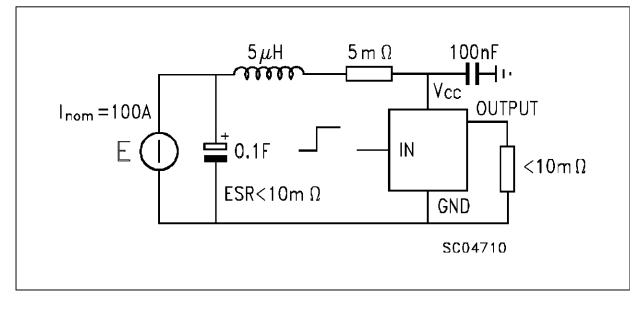


Figure 2: Over Current Test Circuit





VN02NSP

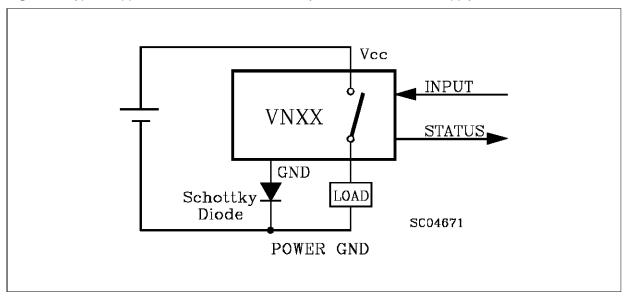
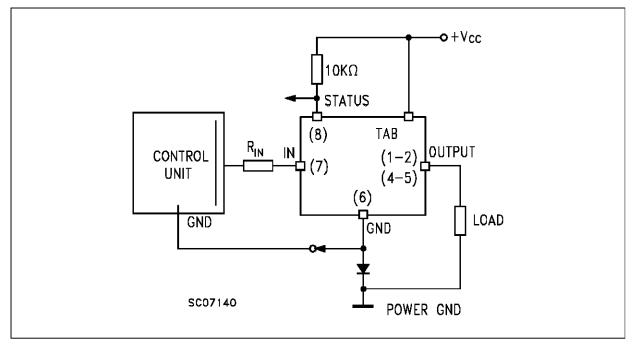
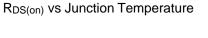


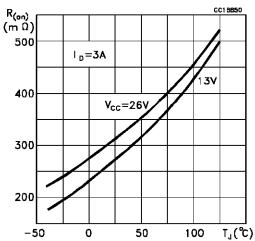
Figure 3: Typical Application Circuit With A Schottky Diode For Reverse Supply Protection

Figure 4: Typical Application Circuit With Separate Signal Ground

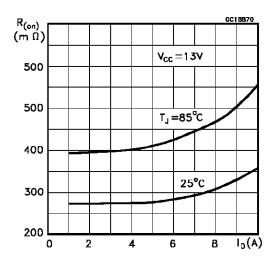




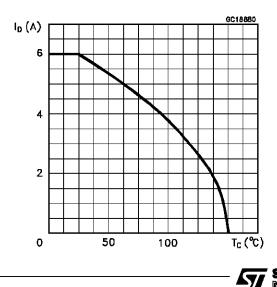




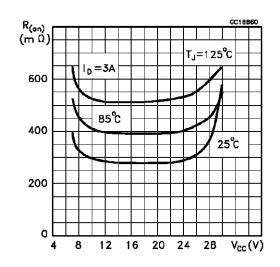
RDS(on) vs Output Current



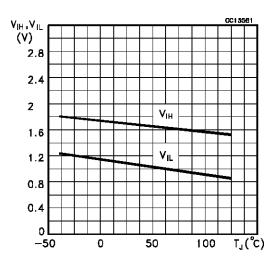
Output Current Derating



R_{DS(on)} vs Supply Voltage

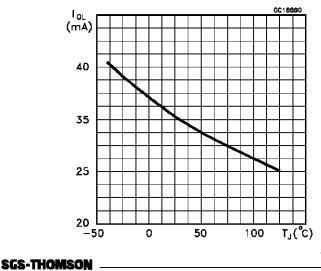


Input voltages vs Junction Temperature



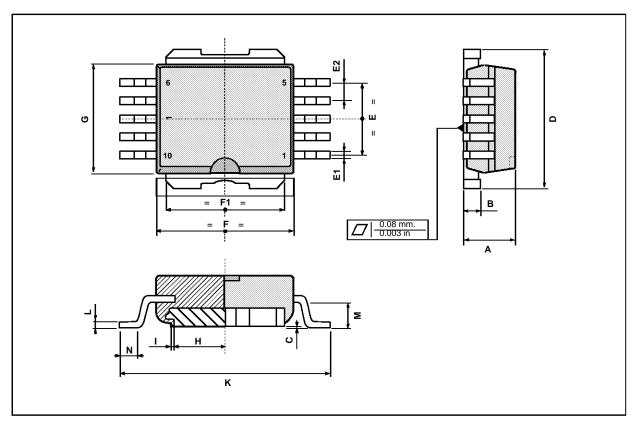
Open Load vs Junction Temperature

MICROELECTRONICS



Power SO-10 MECHANICAL DATA

DIM.		mm			inch	
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	3.45	3.5	3.55	0.135	0.137	0.140
В		1.28	1.30		0.050	0.051
С			0.15			0.006
D	9.40	9.50	9.60	0.370	0.374	0.378
E	4.98	5.08	5.48	0.196	0.200	0.216
E1	0.40	0.45	0.60	0.016	0.018	0.024
E2	1.17	1.27	1.37	0.046	0.050	0.054
F	9.30	9.40	9.50	0.366	0.370	0.374
F1	7.95	8.00	8.15	0.313	0.315	0.321
G	7.40	7.50	7.60	0.291	0.295	0.299
Н	6.80	6.90	7.00	0.267	0.417	0.421
-		0.10			0.004	
к	13.80	14.10	14.40	0.543	0.555	0.567
L		0.40	0.50		0.016	0.020
М	1.60	1.67	1.80	0.063	0.066	0.071
Ν	0.60	0.08	1.00	0.024	0.031	0.039





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